



MICROCIRCUIT DATA SHEET

MNLMH6628-X-RH REV 0A0

Original Creation Date: 04/29/03
 Last Update Date: 05/13/03
 Last Major Revision Date:

**DUAL WIDEBAND, LOW-NOISE, VOLTAGE FEEDBACK OP AMP,
 GUARANTEED TO 300k rd(Si) TESTED TO MIL-STD-883,
 METHOD 1019**

General Description

The National LMH6628 is a high speed dual op amp that offers a traditional voltage feedback topology featuring unity-gain stability and slew-enhanced circuitry. The LMH6628's low noise and very low harmonic distortion combine to form a very wide dynamic range op amp that operates from a single (5 to 12V) or dual ($\pm 5V$) power supply.

Each of the LMH6628's closely matched channels provides a 300MHz unity gain bandwidth and low input voltage noise density (2nV/SqRtHz). Low 2nd/3rd harmonic distortion (-65/-74dBc at 10MHz) makes the LMH6628 a perfect wide dynamic-range amplifier for matched I/Q channels.

With its fast and accurate settling (12ns to 0.1%), the LMH6628 is also an excellent choice for wide dynamic range, anti-aliasing filters to buffer the inputs of hi resolution analog-to-digital converters. Combining the LMH6628's two tightly matched amplifiers in a single package reduces cost and board space for many composite amplifier applications such as active filters, differential line drivers/receivers, fast peak detectors and instrumentation amplifiers.

The LMH6628 is fabricated using National's VIP 10 (TM) complimentary bipolar process.

Industry Part Number

LMH6628

Prime Die

LMH6628A

NS Part Numbers

LMH6628J-QML
 LMH6628J-QMLV
 LMH6628JFQML
 LMH6628JFQMLV
 LMH6628WG-QML
 LMH6628WG-QMLV
 LMH6628WGFQML
 LMH6628WGFQMLV

Controlling Document

SEE FEATURES SECTION

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp Description

Temp (°C)

1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

- Wide unity-gain bandwidth: 300 MHz
- Low noise: 2.0nV/SqRtHz
- Low distortion: -65/-74dBc (10MHz)
- Settling time: 12ns to 0.1%
- Wide supply voltage range: $\pm 2.5V$ to $\pm 6V$
- High output current $\pm 85mA$
- Improved replacement for CLC428

CONTROLLING DOCUMENTS:

LMH6628J-QML	5962-0254501MPA
LMH6628J-QMLV	5962-0254501VPA
LMH6628JFQML	5962F0254501MPA
LMH6628JFQMLV	5962F0254501VPA
LMH6628WG-QML	5962-0254501MZA
LMH6628WG-QMLV	5962-0254501VZA
LMH6628WGFQML	5962F0254501MZA
LMH6628WGFQMLV	5962F0254501VZA

Applications

- High speed dual op amp
- Low noise integrators
- Low noise active filters
- Driver/receiver for transmission systems
- High-speed detectors
- I/Q channel amplifiers

(Absolute Maximum Ratings)

(Note 1)

Supply Voltage		±7V dc
Maximum Junction temperature (Note 2)		+175 C
Lead temperature Soldering, 10 seconds		+300 C
Differential input voltage		V+ - V-
Common mode input voltage		V+ - V-
Storage temperature range		-65 C ≤ Ta ≤ +150 C
Power Dissipation (Note 2)		1.0W
Short circuit current (Note 3)		
Thermal Resistance		
ThetaJA		
Ceramic DIP	(Still Air)	135 C/W
	(500LF/Min Air Flow)	75 C/W
Ceramic SOIC	(Still Air)	200 C/W
	(500LF/Min Air Flow)	145 C/W
ThetaJC		
Ceramic DIP		30 C/W
Ceramic SOIC		19 C/W
Package Weight (typical)		
Ceramic DIP		TBD
Ceramic SOIC		TBD
ESD Tolerance (Note 4)		4000V

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to ambient thermal resistance), and TA (ambient temperature). The maximum allowable power dissipation at any temperature is Pdmax = (Tjmax - TA) / ThetaJA or the number given in the Absolute Maximum Ratings, whichever is lower.

Note 3: Output is short circuit protected to ground, however maximum reliability is obtained if output current does not exceed 160mA.

Note 4: Human body model, 1.5k Ohms in series with 100pF.

Recommended Operating Conditions

Supply Voltage

$\pm 2.5\text{V}$ to $\pm 6.0\text{V}$

Ambient Operating Temperature Range

$-55\text{ C} \leq T_a \leq +125\text{ C}$

Electrical Characteristics

DC PARAMETERS: Static and DC Tests

(The following conditions apply to all the following parameters, unless otherwise specified.)

DC: $V_{cc} = \pm 5V$ dc, $A_v = +2$, $R_l = 100$ Ohms, $R_f = 100$ Ohms, $-55\text{ C} \leq T_a \leq +125\text{ C}$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
I _b	Input Bias Current		3		-10	+10	uA	1
					-20	+20	uA	2
					-20	+20	uA	3
V _{io}	Input Offset Voltage		3		-2	+2	mV	1
					-2.6	+2.6	mV	2, 3
I _{cc}	Supply Current	R _l = infinity	3			24	mA	1
						24	mA	2
						25	mA	3
PSRR	Power Supply Rejection Ration	+V _s = +4.0V to +5.0v, -V _s = -4.0V to -5.0V			60		dB	1
					55		dB	2, 3
V _{out}	Output Voltage Range	R _l = Infinity			-5.0	+5.0	V	1, 2, 3

AC PARAMETERS: Frequency Domain Response

(The following conditions apply to all the following parameters, unless otherwise specified.)

AC: $V_{cc} = \pm 5V$ dc, $A_v = +2$, $R_l = 100$ Ohms, $R_f = 100$ Ohms, $-55\text{ C} \leq T_a \leq +125\text{ C}$

SSBW	Small Signal Bandwith	-3 dB bandwidth, $V_{out} < 0.5$ V _{pp}	2		50		MHz	4
GFP	Gain Flatness Peaking	0.1 MHz to 200 MHz, $V_{out} \leq 0.5$ V _{pp}	2			0.6	dB	4
GFR	Gain Flatness Rolloff	0.1 MHz to 20 MHz, $V_{out} \leq 0.5$ V _{pp}	2			0.6	dB	4
A _{ol}	Open Loop Gain		2		55		dB	4

AC PARAMETERS: Distortion and Noise Tests.

(The following conditions apply to all the following parameters, unless otherwise specified.)

AC: $V_{cc} = \pm 5V$ dc, $A_v = +2$, $R_l = 100$ Ohms, $R_f = 100$ Ohms, $-55\text{ C} \leq T_a \leq +125\text{ C}$

HD2	Second Harmonic Distortion	1 V _{pp} at 10 MHz	2			50	dBc	4
HD3	Third Harmonic Distortion	1 V _{pp} at 10 MHz	2			60	dBc	4

Electrical Characteristics

DC PARAMETERS: DRIFT VALUES

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: " Deltas not required on B-Level product. Deltas required for S-Level product at Group B5 ONLY, or as specified on the Internal Processing Instructions (IPI).

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
I _b	Input Bias Current		1		-1.0	+1.0	uA	1
V _{io}	Input Offset Voltage		1		-0.2	+0.2	mV	1
I _{cc}	Supply Current	R _l = Infinity	1		-1	+1	mA	1

Note 1: If not tested, shall be guaranteed to the limits specified in table 1.

Note 2: Group A testing only.

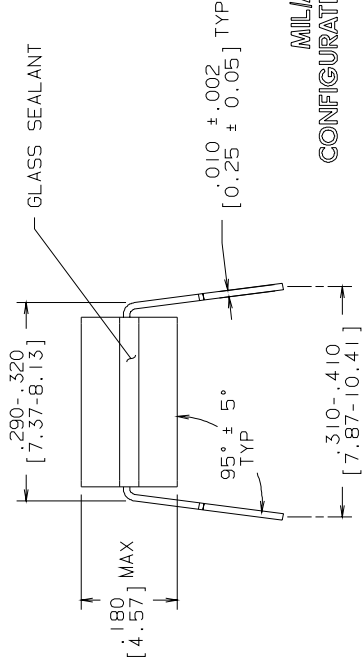
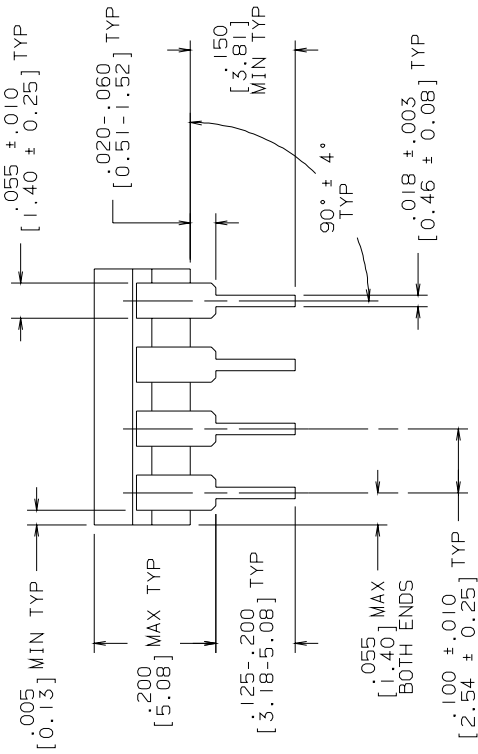
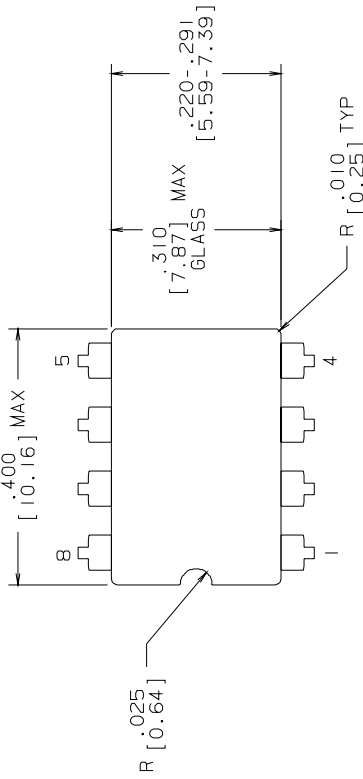
Note 3: Pre and post irradiation limits are identical to those listed under electrical characteristics. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in MIL-STD-883, Method 1019.

Graphics and Diagrams


GRAPHICS#	DESCRIPTION
06403HRA1	CERAMIC SOIC (WG), 10 LEAD (B/I CKT)
07082HRA4	CERDIP (J), 8 LEAD (B/I CKT)
J08ARL	CERDIP (J), 8 LEAD (P/P DWG)
P000480A	CERDIP (J), 8 LEAD (PIN OUT)
P000484A	CERAMIC SOIC (WG), 10 LEAD (PIN OUT)
WG10ARC	CERAMIC SOIC (WG), 10 LEAD (P/P DWG)

See attached graphics following this page.

R E V I S I O N S			
LTR	DESCRIPTION	E. C. N.	DATE
L	REVISE PER CURRENT STD; REDRAW	10002	09/21/93
			TL/



MILAERO
CONFIGURATION CONTROL
MIL-M-38510
CONFIGURATION CONTROL

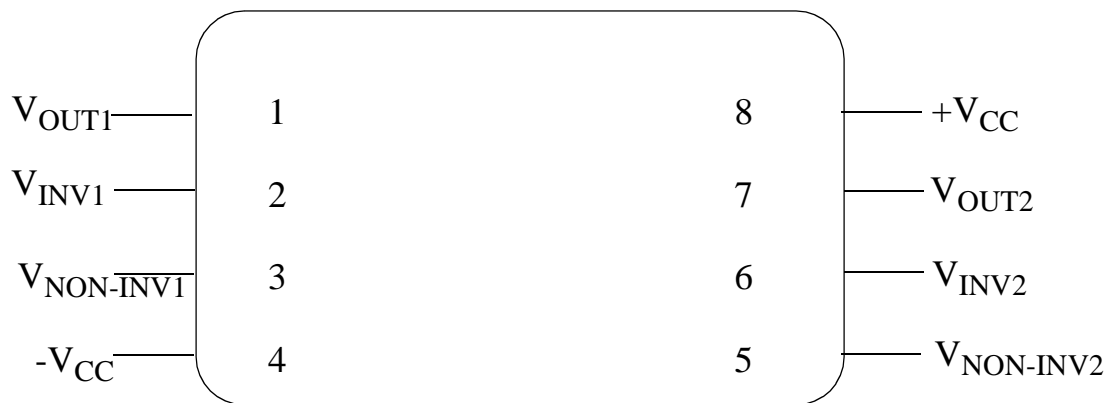
CONTROLLING DIMENSION: INCH	
APPROVALS	DATE
DRAWN  T. LEQUANG	09/21/93
DFTG. CHK.	
ENGR. CHK.	
APPROVAL	
 PROJECTION INCH [MM]	
SCALE N/A	SIZE B
DO NOT SCALE DRAWING	DRAWING NUMBER MKT-J08A
SHEET 1	OF 1

NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

CERDIP (J),
8 LEAD

NOTES: UNLESS OTHERWISE SPECIFIED

- LEAD FINISH TO BE 200 MICROMETERS / 5.08 MICROMETERS MINIMUM SOLDER MEASURED AT THE CREST OF THE MAJOR FLATS.
- JEDEC REGISTRATION MO-036, VARIATION AA, DATED 04/1981.



LMH6628J

8 - LEAD DIP

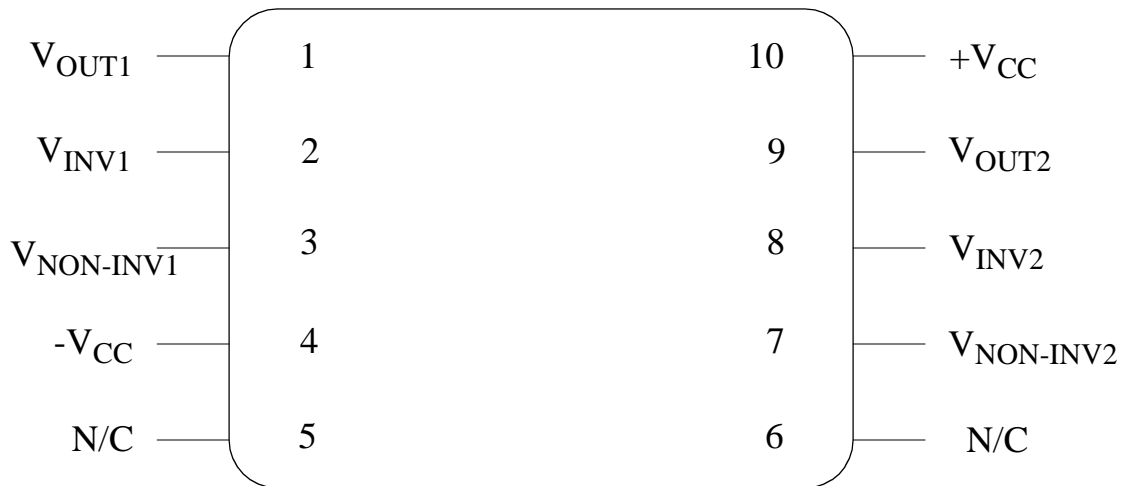
CONNECTION DIAGRAM

TOP VIEW

P000480A



National Semiconductor
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050



LMH6628WG
10 - LEAD CERAMIC SOIC
CONNECTION DIAGRAM
TOP VIEW
P000484A

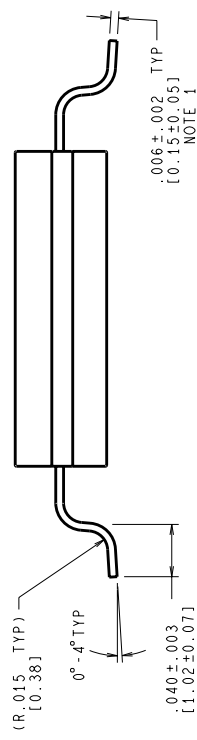
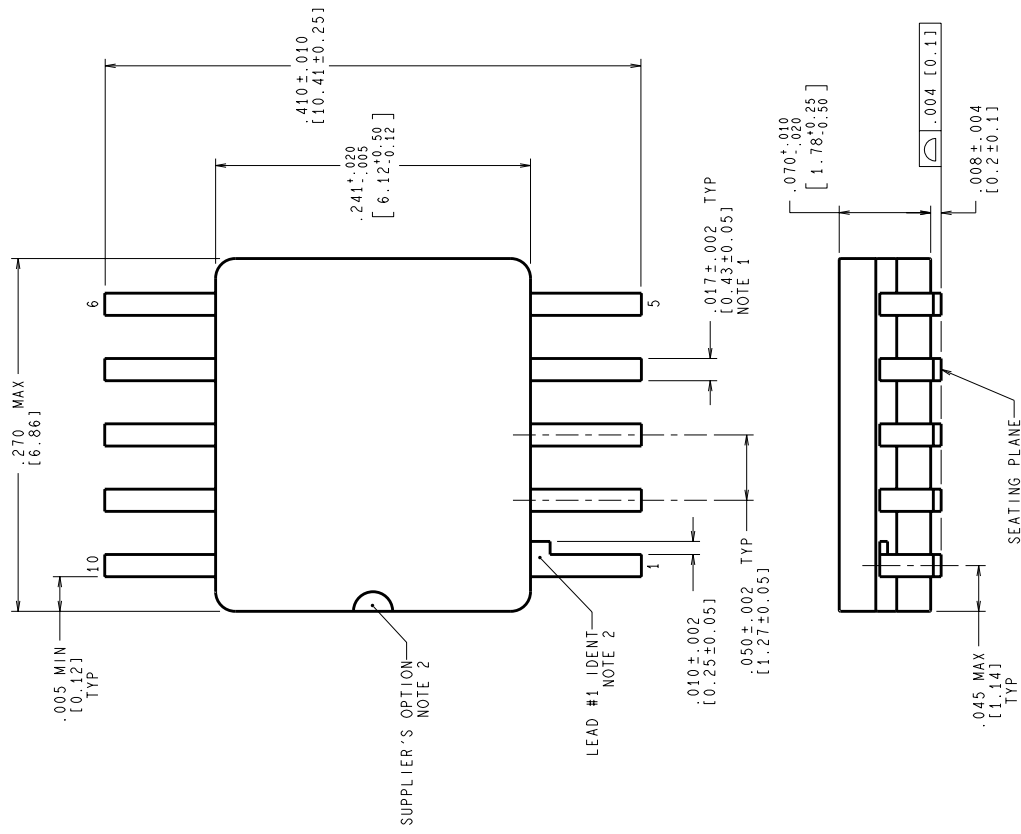


National Semiconductor™

MIL/AEROSPACE OPERATIONS
 2900 SEMICONDUCTOR DRIVE
 SANTA CLARA, CA 95050

REVISIONS

LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	11374	02/29/1996	MS/KH
B	LD PITCH TOL WAS ±.005; CHANGE LD RADIUS TO REF DIM; REMOVE THE OTHER R.006±.002 DIM. .040±.003 WAS .037±.003	11441	04/19/1996	MS/KH
C	R .015(0.38) WAS R .006(0.15)	11838	10/08/1997	TL/



CONTROLLING DIMENSION IS INCH
VALUES IN | | ARE MILLIMETERS

MIL-PRF-38535
CONFIGURATION CONTROL

NOTES: UNLESS OTHERWISE SPECIFIED

- LEAD FINISH: SOLDER DIPPED WITH Sn60 OR Sn63 SOLDER CONFORMING TO MIL-PRF-38535 TO A MINIMUM THICKNESS OF 200 MICRONS/ 5.08 MICROMETERS. SOLDER MAY BE APPLIED OVER LEAD BASIS METAL OR Sn PLATE. MAXIMUM LIMIT MAY BE INCREASED BY .003 IN/ 0.08mm AFTER LEAD FINISH APPLIED.
- LEAD 1 IDENTIFICATION SHALL BE:
 - A NOTCH OR OTHER MARK WITHIN THIS AREA
 - A TAB ON LEAD 1, EITHER SIDE
- NO JEDEC REGISTRATION AS OF FEBRUARY 1996.

APPROVALS	DATE	SCALE	SIZE	DRAWING NUMBER	REV
DRN: MARYA SUCHY	02/29/96	N/A	C	(SC)MKT-WG10A	C
DATE: 02/29/96					
CHK: [Signature]					
PROJECTION					
NATIONAL SEMICONDUCTOR 2800 Semiconductor Dr., Santa Clara, CA 95052-8090					
CERPACK, 10 LEAD, GULL WING					
DO NOT SCALE DRAWING SHEET 1 of 1					

Revision History

Rev	ECN #	Rel Date	Originator	Changes
0A0	M0004149	05/13/03	Rose Malone	Initial MDS Release: MNLMH6628-X-RH, Rev. 0A0